

### 1. Features

- Typical 1dB bandwidth of 19.3 MHz
- High attenuation
- Single Ended Operation
- Dual In-line Package (DIP)

**RoHS Compliant**

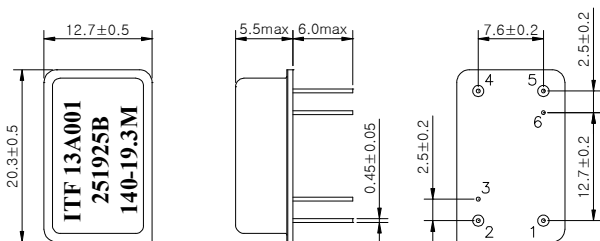
Tested by SGS Testing Korea

### 2. Electrical Specifications

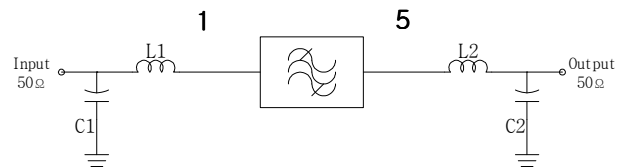
Source and Load Impedance = 50Ω

Room Temperature : +25°C		Minimum	Typical	Maximum
Center Frequency (fo)	MHz	-	145.0	-
Insertion Loss	dB	-	26.5	28.0
1 dB Bandwidth	MHz	19.15	19.36	-
3dB Bandwidth	MHz	-	19.68	-
20dB Bandwidth	MHz	-	20.6	20.65
40dB Bandwidth	MHz	-	21.05	-
Amplitude Ripple (fo ± 9.4 MHz)	dB	-	1.1	1.5
Group Delay Variation (fo ± 9.4 MHz)	nsec	-	40	80
Absolute Delay	usec	-	2.08	-
Ultimate Rejection	dB	40	45	-
Maximum input Power	dBm	-	-	10
Temperature Coefficient of Frequency	ppm/°C	-72		

**D2012 Package Dimension**



**Matching Schematic**



**L1 = 27nH, L2 = 27nH, C1 = 36pF, C2 = 27pF**

Dimensions shown are nominal in millimeters

Base : Fe(SPCC), Au plating over Ni plated

Cap : Cu & Cr Alloy, Ni Plated

Termination : Kovar, Au Plated

**Pin Configuration**

Pin Configuration			
Input	1	Ground	2,4
Output	5	Others	Ground

### 3. Typical Performance ( at +25°C )

